

**IMPACT**

TE Internal #: 2007815-3

High Speed Backplane Connectors, Board-to-Board, 120 Position,  
Mating Alignment, Keyed Mating Alignment Type, 12 Row, 10  
Column, IMPACT

[View on TE.com >](#)

Connectors > PCB Connectors > Backplane Connectors > High Speed Connectors

Connector System: **Board-to-Board**Number of Positions: **120**Row-to-Row Spacing: **1.35 mm [ .053 in ]**Mating Alignment: **With**Mating Alignment Type: **Keyed****Features****Product Type Features**

Signal Arrangement	Differential
Connector System	Board-to-Board
PCB Connector Assembly Type	PCB Mount Header
Shroud Style	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

**Configuration Features**

Number of Ground Positions	40
Number of Pairs	40
Stackable	No
Number of Signal Positions	80
Number of Positions	120
Number of Rows	12
Number of Columns	10
PCB Mount Orientation	Vertical
Guide Location	Right

**Electrical Characteristics**

Impedance	100 $\Omega$
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Operating Voltage	30 VAC
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### Signal Characteristics

Number of Differential Pairs per Column	4
Data Rate	20 – 25 Gb/s

### Contact Features

Contact Layout	Inline
Contact Mating Area Length	5.5 mm[.217 in]
PCB Contact Termination Area Plating Material Thickness	.76 – 1.52 $\mu\text{m}$ [30 – 60 $\mu\text{in}$ ]
Contact Type	Pin
Contact Underplating Material Thickness	1.27 $\mu\text{m}$ [50 $\mu\text{in}$ ]
Contact Mating Area Plating Material Thickness	.76 $\mu\text{m}$ [29.92 $\mu\text{in}$ ]
Contact Mating Area Plating Material	Gold
PCB Contact Termination Area Plating Material Finish	Matte
Contact Shape & Form	Dual Beam
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Alloy
Contact Current Rating (Max)	.75 A

### Termination Features

Termination Post & Tail Length	1.4 mm[.055 in]
Termination Method to Printed Circuit Board	Through Hole - Press-Fit

### Mechanical Attachment

Mating Retention	Without
Guide Hardware	With
PCB Mount Retention	With
PCB Mount Retention Type	Action/Compliant Tail & Screw
Mating Alignment	With
Mating Alignment Type	Keyed
Connector Mounting Type	Board Mount

### Housing Features

Number of Shrouded Sides	3
End Wall Location	Left



Housing Material	LCP - GF (Liquid Crystal Polymer)
Housing Color	Black
Centerline (Pitch)	1.9 mm[.075 in]

### Dimensions

Connector Length	26.9 mm[1.059 in]
Stack Height	11.95 mm
Connector Height	24.6 mm[.47 in]
Connector Width	20.8 mm[.819 in]
PCB Thickness (Recommended)	1 mm
PCB Hole Diameter	.39 mm[.015 in]
Row-to-Row Spacing	1.35 mm[.053 in]

### Usage Conditions

Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]
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### Operation/Application

Circuit Application	Signal
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### Industry Standards

UL File Number	E28476
UL Rating	Recognized
CSA Certified	Yes
UL Flammability Rating	UL 94V-0

### Packaging Features

Packaging Method	Box & Tube, Tube
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### Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per

homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Not applicable for solder process capability

#### Product Compliance Disclaimer

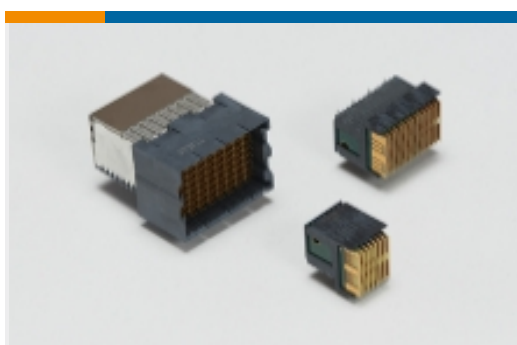
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

## Compatible Parts



TE Part # 2007711-1  
IMP100S,R,RA3P16C,UG,39

## Also in the Series | IMPACT



High Speed Backplane Connectors  
(1769)

## Documents

### Product Drawings

IMP100S,H,V4P10C,RG,LEW39,5.5

English

### CAD Files

3D PDF

3D



**Customer View Model**

[ENG\\_CVM\\_CVM\\_2007815-3\\_A.2d\\_dxf.zip](#)

English

**Customer View Model**

[ENG\\_CVM\\_CVM\\_2007815-3\\_A.3d\\_igs.zip](#)

English

**Customer View Model**

[ENG\\_CVM\\_CVM\\_2007815-3\\_A.3d\\_stp.zip](#)

English

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**Product Specifications**

[Application Specification](#)

English

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**Agency Approvals**

[Agency Approval Document](#)

English